

# 100 mA Low-Dropout Regulator

#### **Features**

- · High Output Voltage Accuracy
- Variety of Output Voltages
- · Guaranteed 100 mA Output
- · Low Quiescent Current
- · Low Dropout Voltage
- · Extremely Tight Load and Line Regulation
- · Very Low Temperature Coefficient
- · Current and Thermal Limiting
- · Zero OFF Mode Current
- · Logic-Controlled Electronic Shutdown
- Available in 8-Lead SOIC, MM8 8-Lead MSOP, and SOT-223 Packages

#### **Applications**

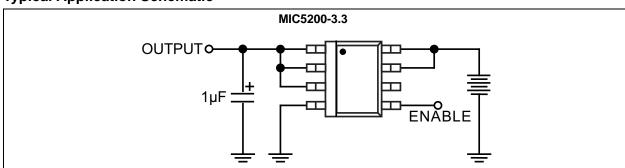
- · Cellular Telephones
- · Laptop, Notebook, and Palmtop Computers
- · Battery-Powered Equipment
- PCMCIA V<sub>CC</sub> and V<sub>PP</sub> Regulation/Switching
- · Barcode Scanners
- · SMPS Post-Regulator/DC-to-DC Modules
- High Efficiency Linear Power Supplies

#### **General Description**

The MIC5200 is an efficient linear voltage regulator with very low dropout voltage (typically 17 mV at light loads and 200 mV at 100 mA), and very low ground current (1 mA at 100 mA output), offering better than 1% initial accuracy with a logic-compatible ON/OFF switching input. Designed especially for hand-held battery-powered devices, the MIC5200 is switched by a CMOS- or TTL-compatible logic signal. The ENABLE control may be tied directly to  $\rm V_{IN}$  if unneeded. When disabled, power consumption drops nearly to zero. The ground current of the MIC5200 increases only slightly in dropout, further prolonging battery life. Key MIC5200 features include protection against reversed battery, current limiting, and overtemperature shutdown.

The MIC5200 is available in several fixed voltages and accuracy configurations. Other options are available; contact Microchip for details.

#### **Typical Application Schematic**



#### 1.0 ELECTRICAL CHARACTERISTICS

### **Absolute Maximum Ratings †**

| Input Supply Voltage | –20V to +60V       |
|----------------------|--------------------|
| Enable Input Voltage |                    |
| Power Dissipation    | Internally Limited |
| Operating Detings +  |                    |
| Operating Ratings ‡  |                    |

**<sup>†</sup> Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

Enable Input Voltage ...... –20V to V<sub>IN</sub>

**<sup>‡</sup> Notice:** The device is not guaranteed to function outside its operating ratings.

#### TABLE 1-1: ELECTRICAL CHARACTERISTICS

**Electrical Characteristics:** Limits in standard typeface are for  $T_J$  = 25°C and limits in **boldface** apply over the junction temperature range of –40°C to +125°C. Unless otherwise specified,  $V_{IN}$  =  $V_{OUT}$  + 1V,  $I_L$  = 1 mA,  $C_L$  = 3.3  $\mu$ F, and  $V_{ENABLE}$  =  $V_{DD}$ . (Note 1).

| Parameters                             | Sym.                              | Min. | Тур.  | Max. | Units  | Conditions   |
|--|-----------------------------------|------|-------|------|--------|--|
| Outrot Mallaga Agains                  |                                   | -1   | _     | 1    | 0/     | Variation from specified V <sub>OUT</sub>                                    |
| Output Voltage Accuracy                | Vo                                | -2   | _     | 2    | %      |  |
| Output Voltage Temperature Coefficient | ΔV <sub>O</sub> /ΔΤ               | _    | 40    | 150  | ppm/°C | Note 2   |
| Line Regulation                        | ۸۱/ ۸/                            | _    | 0.004 | 0.10 | - %    | \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\                                       |
| Line Regulation                        | $\Delta V_{O}/V_{IN}$             | _    | _     | 0.40 | 70     | $V_{IN} = V_{OUT} + 1V \text{ to } 26V$                                      |
| Load Regulation                        | A\/ A/                            | _    | 0.04  | 0.16 | %      | I <sub>L</sub> = 0.1 mA to 100 mA (Note 3)                                   |
| Load Regulation                        | ΔV <sub>O</sub> /V <sub>OUT</sub> | _    | _     | 0.30 | 70     | IL = 0.1 IIIA to 100 IIIA (Note 3)   |
|  |                                   | _    | 17    | _    |        | I <sub>L</sub> = 100 μA  |
|  |                                   | _    | 130   | _    |        | I <sub>L</sub> = 20 mA   |
| Dropout Voltage (Note 4)               | $V_{IN} - V_{O}$                  | _    | 150   | _    | mV     | I <sub>L</sub> = 30 mA   |
|  |                                   | _    | 190   |      |        | I <sub>L</sub> = 50 mA   |
|  |                                   | _    | 230   | 350  |        | I <sub>L</sub> = 100 mA  |
| Quiescent Current                      | I <sub>GND</sub>                  | _    | 0.01  | 10   | μA     | V <sub>ENABLE</sub> ≤ 0.7V (shutdown)  |
|  |                                   | _    | 130   | _    |        | $V_{\text{ENABLE}} = V_{\text{DD}}, I_{\text{L}} = 100 \mu\text{A}$          |
|  |                                   | _    | 270   | 350  |        | I <sub>L</sub> = 20 mA   |
| Ground Pin Current                     | I <sub>GND</sub>                  | _    | 330   | _    | μA     | I <sub>L</sub> = 30 mA   |
|  |                                   | _    | 500   | _    |        | I <sub>L</sub> = 50 mA   |
|  |                                   | _    | 1000  | 1500 |        | I <sub>L</sub> = 100 mA  |
| Ripple Rejection                       | PSRR                              | _    | 70    | _    | dB     | _  |
| Ground Pin Current at Dropout          | I <sub>GNDDO</sub>                |      | 270   | 330  | μA     | $V_{IN}$ = 0.5V less than specified $V_{OUT}$ , $I_L$ = 100 $\mu$ A (Note 5) |
| Current Limit                          | I <sub>LIMIT</sub>                | 100  | 250   | _    | mA     | V <sub>OUT</sub> = 0V  |
| Thermal Regulation                     | $\Delta V_O / \Delta P_D$         | _    | 0.05  |      | %/W    | Note 6   |
| Output Noise                           | e <sub>n</sub>                    | _    | 100   | _    | μV     | _  |

- Note 1: Specification for packaged product only.
  - **2:** Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
  - 3: Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1 mA to 100 mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
  - **4:** Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.
  - **5:** Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.
  - **6:** Thermal regulation is defined as the change in output voltage at a time (t) after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a 100 mA load pulse at V<sub>IN</sub> = 26V for t = 10 ms.

# MIC5200

#### TABLE 1-1: ELECTRICAL CHARACTERISTICS (CONTINUED)

**Electrical Characteristics:** Limits in standard typeface are for  $T_J$  = 25°C and limits in **boldface** apply over the junction temperature range of –40°C to +125°C. Unless otherwise specified,  $V_{IN}$  =  $V_{OUT}$  + 1V,  $I_L$  = 1 mA,  $C_L$  = 3.3  $\mu$ F, and  $V_{ENABLE}$  =  $V_{DD}$ . (Note 1).

| Parameters                      | Sym.            | Min. | Тур. | Max. | Units | Conditions             |
|---------------------------------|-----------------|------|------|------|-------|------------------------|
| ENABLE Input                    |                 |      |      |      |       |                        |
| Input Voltage Level, Logic Low  | $V_{IL}$        | _    |      | 0.7  | \/    | OFF                    |
| Input Voltage Level, Logic High | $V_{IH}$        | 2.0  | _    | _    | V     | ON                     |
| English land Comment            | I <sub>IL</sub> | _    | 0.01 | 1    |       | V <sub>IL</sub> ≤ 0.7V |
| Enable Input Current            | I <sub>IH</sub> | _    | 15   | 50   | μA    | V <sub>IH</sub> ≥ 2.0V |

- Note 1: Specification for packaged product only.
  - 2: Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
  - 3: Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1 mA to 100 mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
  - **4:** Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.
  - **5:** Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.
  - **6:** Thermal regulation is defined as the change in output voltage at a time (t) after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a 100 mA load pulse at V<sub>IN</sub> = 26V for t = 10 ms.

#### TEMPERATURE SPECIFICATIONS

| Parameters                           | Sym.           | Min. | Тур. | Max. | Units | Conditions    |
|--------------------------------------|----------------|------|------|------|-------|---------------|
| Temperature Ranges                   |                |      |      |      |       |               |
| Junction Operating Temperature Range | T <sub>J</sub> | -40  | _    | +125 | °C    | Note 1        |
| Lead Temperature                     | _              | _    | _    | +260 | °C    | Soldering, 5s |
| Package Thermal Resistances          |                |      |      |      |       |               |
| Thermal Resistance, SOT-223          | $\theta_{JC}$  | _    | 15   | _    | °C/W  | _             |
| Thermal Resistance, SOIC-8           | $\theta_{JA}$  | _    | 160  | _    | °C/W  | Note 2        |

- Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T<sub>A</sub>, T<sub>J</sub>, θ<sub>JA</sub>). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.
  - 2: The maximum allowable power dissipation at any ambient temperature is calculated using:  $P_{(MAX)} = (T_{J(MAX)} T_A) \div \theta_{JA}$ . Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown. The  $\theta_{JC}$  of the MIC5200-x.xYS is 15°C/W and  $\theta_{JA}$  for the MIC5200YM is 160°C/W mounted on a PC board (see Thermal Considerations for further details).

#### 2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

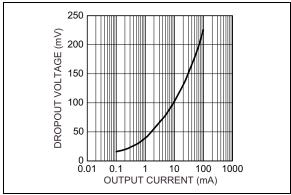
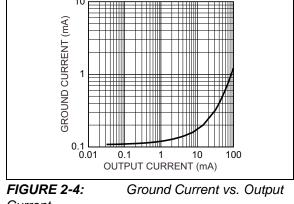


FIGURE 2-1: Dropout Voltage vs. Output Current.



Current.

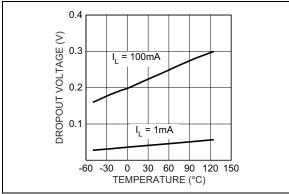
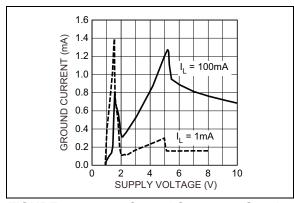


FIGURE 2-2: Dropout Voltage vs. Temperature.



**FIGURE 2-5:** Ground Current vs. Supply Voltage.

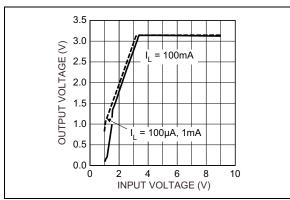


FIGURE 2-3: Dropout Characteristics.

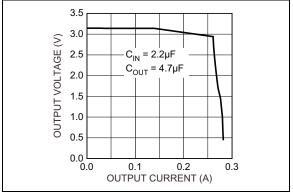


FIGURE 2-6: Output Voltage vs. Output Current.

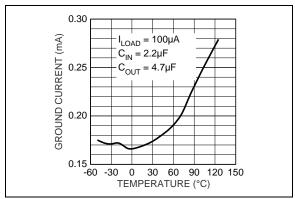


FIGURE 2-7: Ground Current vs. Temperature.

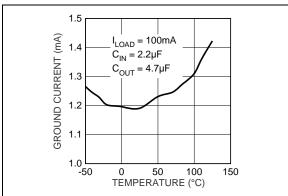


FIGURE 2-8: Ground Current vs. Temperature.

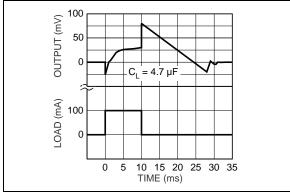


FIGURE 2-9: Thermal Regulation (3.3V Version).

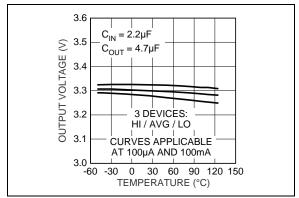


FIGURE 2-10: Output Voltage vs. Temperature (3.3V Version).

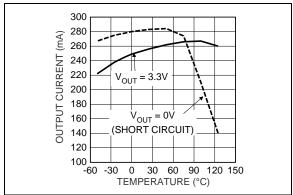


FIGURE 2-11: Output Current vs. Temperature.

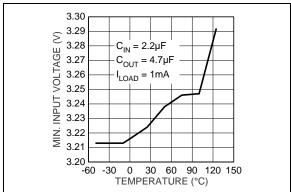


FIGURE 2-12: Minimum Input Voltage vs. Temperature.

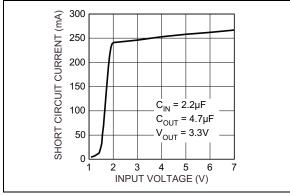
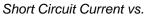


FIGURE 2-13: Short Input Voltage.



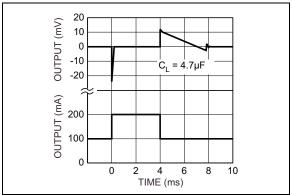


FIGURE 2-14: Load Transient.

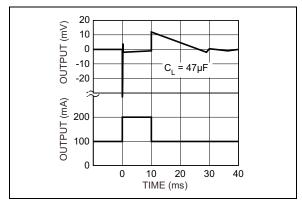


FIGURE 2-15: Load Transient.

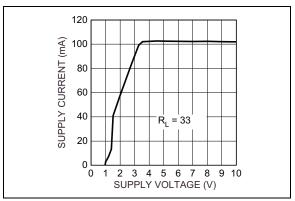


FIGURE 2-16: Supply Current vs. Supply Voltage (3.3V Version).

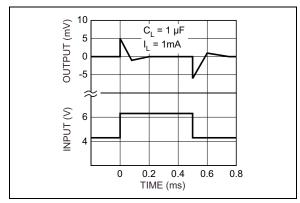


FIGURE 2-17: Line Transient.

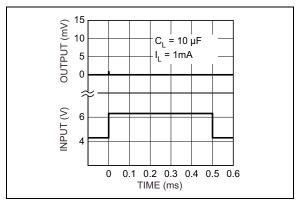


FIGURE 2-18: Line Transient.

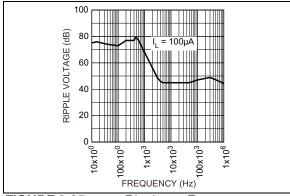


FIGURE 2-25: Ripple vs. Frequency.

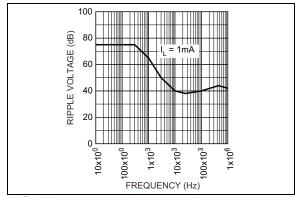


FIGURE 2-26: Ripple vs. Frequency.

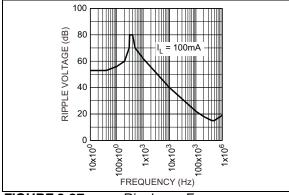


FIGURE 2-27: Ripple vs. Frequency.

#### 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

## **Package Types**

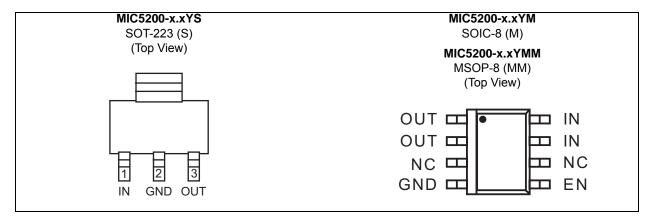


TABLE 3-1: PIN FUNCTION TABLE

| Pin Number<br>SOT-223 | Pin Number<br>SOIC-8,<br>MSOP-8 | Pin Name | Description   |
|-----------------------|---------------------------------|----------|---|
| 3                     | 1, 2                            | OUT      | Output: Pins 1 and 2 (SOIC-8, MSOP-8 packages) must be externally connected together.       |
| _                     | 3, 6                            | NC       | Not internally connected. Connect to ground place for lowest thermal resistance.            |
| 2, TAB                | 4                               | GND      | Ground: Ground pin and TAB (SOT-223 package) are internally connected.                      |
| _                     | 5                               | EN       | Enable/Shutdown (Input): TTL-compatible. High = enabled; low = shutdown.                    |
| 1                     | 7, 8                            | IN       | Supply Input: Pins 7 and 8 (SOIC-8, MSOP-8 packages) must be externally connected together. |

#### 4.0 APPLICATION INFORMATION

#### 4.1 External Capacitors

A 1  $\mu F$  capacitor is recommended between the MIC5200 output and ground to prevent oscillations due to instability. Larger values serve to improve the regulator's transient response. Most types of tantalum or aluminum electrolytics will be adequate; film types will work, but are costly and therefore not recommended. Many aluminum electrolytics have electrolytes that freeze at about  $-30^{\circ}C$ , so solid tantalum capacitors are recommended for operation below  $-25^{\circ}C$ . The important parameters of the capacitor are an effective series resistance of about  $5\Omega$  or less and a resonant frequency above 500 kHz. The value of this capacitor may be increased without limit.

At lower values of output current, less output capacitance is required for output stability. The capacitor can be reduced to 0.47  $\mu F$  for current below 10 mA or 0.33  $\mu F$  for currents below 1 mA. A 1  $\mu F$  capacitor should be placed from the MIC5200 input to ground if there is more than 10 inches of wire between the input and the AC filter capacitor or if a battery is used as the input.

The MIC5200 will remain stable and in regulation with no load in addition to the internal voltage divider, unlike many other voltage regulators. This is especially important in CMOS RAM keep-alive applications.

When used in dual supply systems where the regulator load is returned to a negative supply, the output voltage must be diode clamped to ground.

#### 4.2 **ENABLE Input**

The MIC5200 features nearly zero OFF mode current. When the ENABLE input is held below 0.7V, all internal circuitry is powered off. Pulling this pin high (over 2.0V) re-enables the device and allows operation. The ENABLE pin requires a small amount of current, typically 15  $\mu A.$  While the logic threshold is TTL/CMOS compatible, ENABLE may be pulled as high as 30V, independent of the voltage on  $V_{\text{IN}}.$ 

#### 5.0 THERMAL CONSIDERATIONS

### 5.1 Layout

The MIC5200-x.xYM (8-pin surface mount package) has the following thermal characteristics when mounted on a single-layer copper-clad printed circuit board.

| PC Board Dielectric | $\theta_{JA}$ |
|---------------------|---------------|
| FR4                 | 160 °C/W      |
| Ceramic             | 120 °C/W      |

Multi-layer boards having a ground plane, wide traces near the pads, and large supply bus lines provide better thermal conductivity.

The "worst case" value of 160 °C/W assumes no ground plane, minimum trace widths, and a FR4 material board.

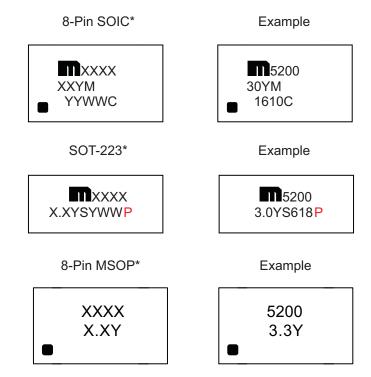
# 5.2 Nominal Power Dissipation and Die Temperature

The MIC5200-x.xYM at a 25°C ambient temperature will operate reliably at up to 625 mW power dissipation when mounted in the "worst case" manner described above. At an ambient temperature of 55°C, the device may safely dissipate 440 mW. These power levels are equivalent to a die temperature of 125°C, the recommended maximum temperature for non-military grade silicon integrated circuits.

For MIC5200-x.xYS (SOT-223 package) heat sink characteristics, please refer to Application Hint 17, "Calculating P.C. Board Heat Sink Area for Surface Mount Packages".

#### 6.0 PACKAGING INFORMATION

#### 6.1 Package Marking Information



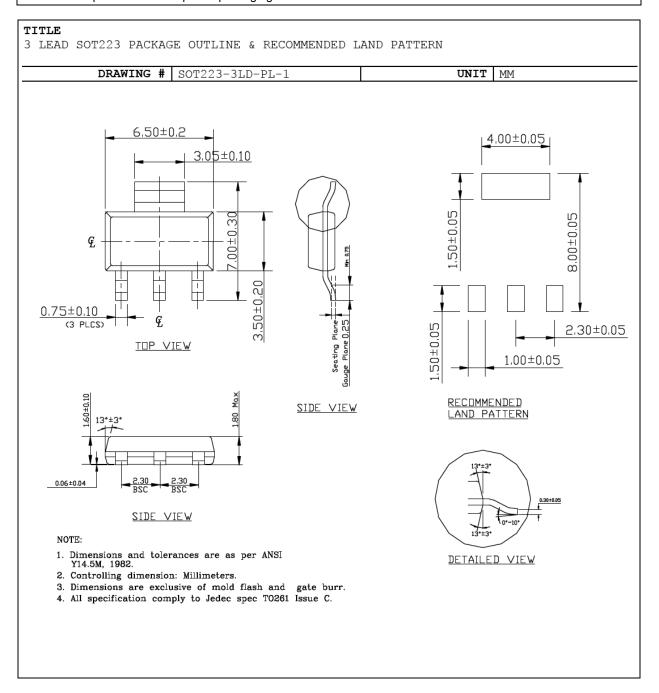
Legend: XX...XProduct code or customer-specific information Υ Year code (last digit of calendar year) ΥY Year code (last 2 digits of calendar year) WW Week code (week of January 1 is week '01') Alphanumeric traceability code NNN Pb-free JEDEC® designator for Matte Tin (Sn) (e3) This package is Pb-free. The Pb-free JEDEC designator (@3) can be found on the outer packaging for this package. •, ▲, ▼ Pin one index is identified by a dot, delta up, or delta down (triangle mark).

**Note**: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.

Underbar ( ) symbol may not be to scale.

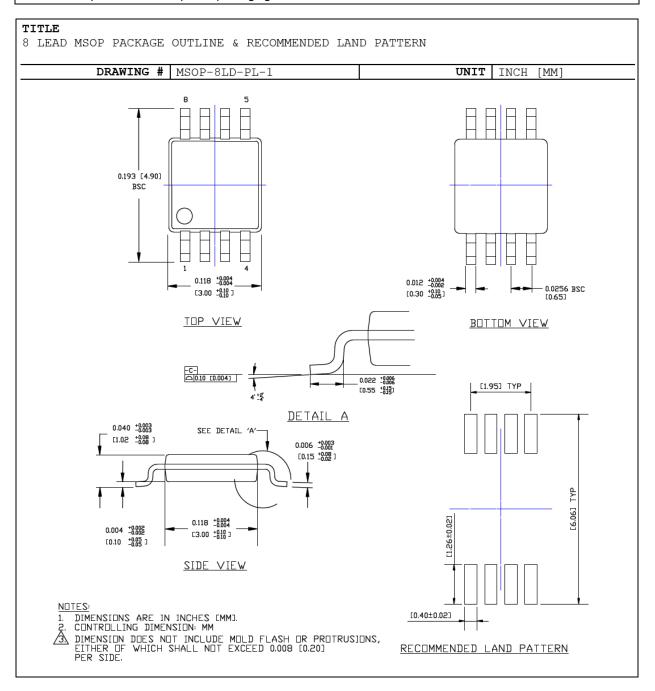
#### **SOT-223 Package Outline and Recommended Land Pattern**

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



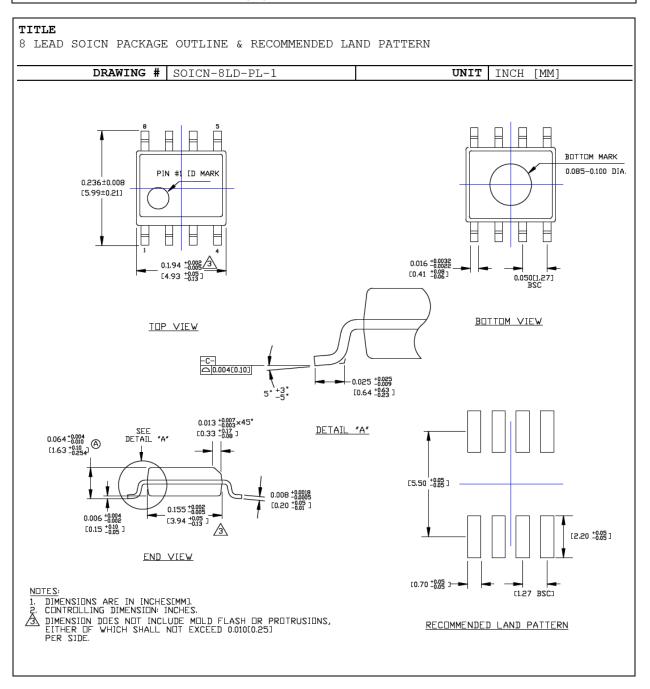
#### 8-Lead MSOP Package Outline and Recommended Land Pattern

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



#### 8-Lead SOIC-N Package Outline and Recommended Land Pattern

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



# **MIC5200**

## **APPENDIX A: REVISION HISTORY**

# Revision A (July 2016)

- Converted Micrel document MIC5200 to Microchip data sheet DS20005578A.
- Minor text changes throughout.



NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

| DARTNO                | VV   | Examples:   |
|-----------------------|--|---|
| PART NO<br>Device     | . – <u>X.X</u> X <u>XX</u> – <u>X.X</u><br>                  | pe a) MIC5200-3.0YM: 100 mA Low-Dropout Regulator, 3.0V Voltage, -40°C to +125°C Temp. Range, 8-Pin SOIC, 95/Tube                 |
| Device: Voltage:      | MIC5200: 100 mA Low-Dropout Regulator  3.0 = 3.0V            | b) MIC5200-4.8YM-TR: 100 mA Low-Dropout Regulator, 4.85 Voltage, -40°C to +125°C Temp. Range, 8-Pin SOIC, 2,500/Reel              |
| (Note 1)              | 3.3 = 3.3V<br>4.8 = 4.8V<br>5.0 = 5.0V                       | c) MIC5200-3.3YMM: 100 mA Low-Dropout Regulator, 3.3V Voltage, -40°C to +125°C Temp. Range, 8-Pin MSOP, 95/Tube                   |
| Temperature: Package: | Y = -40°C to +125°C  M = 8-Pin SOIC  MM = 8-Pin MSOP         | d) MIC5200-5.0YMM-TR: 100 mA Low-Dropout Reg-<br>ulator, 5.0V Voltage, -40°C<br>to +125°C Temp. Range, 8-<br>Pin MSOP, 2,500/Reel |
| Media Type:           | S = SOT-223  TR = 2,500/Reel blank= 95/Tube                  | e) MIC5200-3.3YS: 100 mA Low-Dropout Regulator, 3.3V Voltage, -40°C to +125°C Temp. Range, SOT-223, 95/Tube                       |
|                       | 8-Pin MSOP package (MM) is only available in 3.3V a options. | f) MIC5200-5.0YS-TR 100 mA Low-Dropout Regulator, 5.0V Voltage, -40°C to +125°C Temp. Range, SOT-223, 2,500/ Reel                 |

# MIC5200

**NOTES:** 

#### Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
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